

FUJI POWER MOSFET

Super FAP-G Series

N-CHANNEL SILICON POWER MOSFET

■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

■ Maximum ratings and characteristic

● (Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	VDS	150	V
	VDSX *5	120	V
Continuous drain current	Id	±40	A
Pulsed drain current	Id(puls)	±160	A
Gate-source voltage	VGS	±30	V
Non-repetitive Avalanche current	IAS *2	40	A
Maximum Avalanche Energy	EAS *1	387	mJ
Maximum Drain-Source dV/dt	dVDS/dt *4	20	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	PD	2.16	W
	Ta=25°C		
	Tc=25°C	70	
Operating and storage temperature range	Tch	+150	°C
	Tstg	-55 to +150	°C
Isolation voltage	VISO *6	2	kVrms

*1 L=335μH, Vcc=48V *2 Tch≤150°C *3 If≤ -Id, -di/dt=50A/μs, Vcc≤BVDS, Tch≤150°C

*4 VDS ≤ 150V *5 VGS=-30V *6 t=60sec f=60Hz

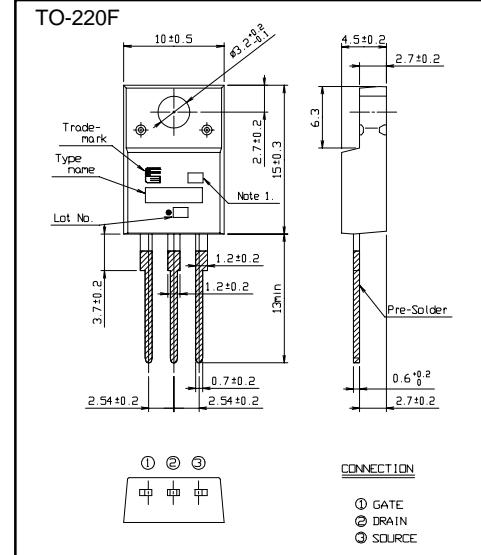
● Electrical characteristics (Tc = 25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id= 250μA VGS=0V	150			V
Gate threshold voltage	VGS(th)	Id= 250μA VDS=VGS	3.0		5.0	V
Zero gate voltage drain current	Idss	VDS=150V VGS=0V		25		μA
		VDS=120V VGS=0V		250		
Gate-source leakage current	IGSS	VGS=±30V VDS=0V		10	100	nA
Drain-source on-state resistance	RDS(on)	Id=20A VGS=10V		31	41	mΩ
Forward transconductance	gfs	Id=20A VDS=25V	13	26		S
Input capacitance	Ciss	VDS=75V		1940	2910	pF
Output capacitance	Coss	VGS=0V		310	465	
Reverse transfer capacitance	Crss	f=1MHz		24	36	
Turn-on time ton	td(on)	Vcc=48V Id=20A		20	30	ns
	tr	VGS=10V		26	39	
Turn-off time toff	td(off)	Rgs=10 Ω		50	75	
	tf			20	30	
Total Gate Charge	QG	Vcc=75V		52	78	nC
Gate-Source Charge	QGS	Id=40A		15	22.5	
Gate-Drain Charge	QGD	VGS=10V		18	27	
Avalanche capability	IAV	L=100μH Tch=25°C	40			A
Diode forward on-voltage	VSD	If=40A VGS=0V Tch=25°C		1.10	1.65	V
Reverse recovery time	trr	If=40A VGS=0V		0.14		μs
Reverse recovery charge	Qrr	-di/dt=100A/μs Tch=25°C		0.77		μC

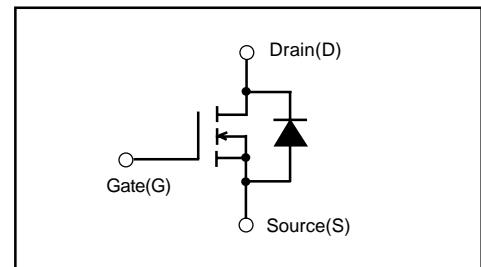
● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			1.786	°C/W
	Rth(ch-a)	channel to ambient			58.0	°C/W

■ Outline Drawings (mm)



■ Equivalent circuit schematic



■ Characteristics

